HPC-6240 + ASMB-622V3

System	**CPU**	Intel 4/5th Gen. Generation Xeon Scalable up to 270W TDP
	Chipsatz	Intel® C741
	Memory	up to 4TB ECC RDIMM (16x 256GB)
	Storage	4x 2,5” SSD Hot-Swap, opt. 2x 2,5” SSD & 2x 2,5” NVMe 2 x M.2 2280/22110 B+M key (SATA and PCIe)
	GPU	AST 2600
	Display	1x VGA
	Ethernet	2x RJ45 GbE LAN + 2x RJ45 10GbE LAN + 1x RJ45 IPMI
	Front I/O Panel	2x USB 3.2 Gen1
	Rear I/O Panel	2x 230V Power in 1x VGA 4x LAN 1GbE + 1x IPMI 2x USB 3.2 Gen1
	PCIe	2x PCIe x16 (Gen5) FH/10.5“ or 4x PCIe x8 (Gen5) FH/10.5“ 4x PCIe x8 (Gen5) FH/HL
	Operating Temperature	0 – 40 °C
	Humidity	10 ~ 95% @ 50 °C, non-condensing
	Vibration (5 ~ 500 Hz)	0.3 Grms / 2 G for internal disks
	Shock	10 G (with 11 ms duration, half sine wave)
	IP	-
Cooling	**Chassis Fan**	3x (8 cm / 132 CFM) 1x (6 cm / 75 CFM)
	Air Filter	No
Power Supply	**Power Supply**	1+0 1200 Watt 100-240V Hot Swap (80+ Platinum) 1+1 1200 Watt 100-240V Hot Swap (80+ Platinum)
Physical Characteristics	**Dimension (HxBxT)**	[2 HE] 88 x 438 x 523 mm
OS	**Windows**	Windows 10/11 Pro / IoT Windows Server 2022 / 2025
	Linux	Linux 64-bit
Optional		20"-31" Slide Rail Kit 1-4 GPU (up to 400W) Lockable front bezel
Available		2033

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